

PATENT  
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: **Hiroshi ITO et al.**

Serial No.: **Not Yet Assigned**  
**(PCT/JP99/07367)**

Filed: **July 3, 2001**

For: **CURABLE RESIN COMPOSITION**

PRELIMINARY AMENDMENT

Commissioner for Patents  
Washington, D.C. 20231

July 3, 2001

Sir:

Prior to the calculation of the filing fees of the above application, please amend the application as follows:

IN THE CLAIMS:

Please amend claims 4, 5, 7, 10 and 11 as follows:

4. (Amended) The curable resin composition according to Claim 1 or 2 wherein the main chain of the reactive silicon group-containing polyether oligomer (I) is mainly formed from polypropylene oxide.